

October 1987 Revised January 1999

# **MM74C86**

# **Quad 2-Input EXCLUSIVE-OR Gate**

## **General Description**

The MM74C86 employs complementary MOS (CMOS) transistors to achieve wide power supply operating range, low power consumption and high noise margin these gates provide basic functions used in the implementation of digital integrated circuit systems. The N- and P-channel enhancement mode transistors provide a symmetrical circuit with output swing essentially equal to the supply voltage. No DC power other than that caused by leakage current is consumed during static condition. All inputs are protected from damage due to static discharge by diode clamps to  $\rm V_{CC}$  and GND.

#### **Features**

■ Wide supply voltage range: 3.0V to 15V

■ Guaranteed noise margin: 1.0V

 $\blacksquare$  High noise immunity: 0.45  $\rm V_{CC}$  (typ.)

■ Low power: TTL compatibility: Fan out of 2 driving 74L

■ Low power consumption: 10 nW/package (typ.)

■ The MM74C86 follows the MM74LS86 Pinout

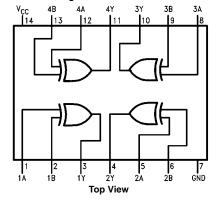
#### **Ordering Code:**

Order Number	Package Number	er Package Description			
MM74C86M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow			
MM74C86N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

## **Connection Diagram**

#### Pin Assignments for DIP and SOIC



#### **Truth Table**

Inputs		Output		
Α	В	Υ		
L	L	L		
L	Н	Н		
Н	L	Н		
Н	Н	L		

H = HIGH Level L = LOW Level

## **Absolute Maximum Ratings**(Note 1)

 $\begin{tabular}{lll} \mbox{Voltage at any Pin (Note 1)} & -0.3\mbox{V to V}_{CC} + 0.3\mbox{V} \\ \mbox{Operating Temperature Range} & -40\mbox{°C to +85\mbox{°C}} \\ \mbox{Storage Temperature Range} & -65\mbox{°C to +150\mbox{°C}} \\ \end{tabular}$ 

Power Dissipation ( $P_D$ )

 $\begin{array}{cc} \text{Dual-In-Line Package} & 700 \text{ mW} \\ \text{Small Outline} & 500 \text{ mW} \\ \text{Operating Range (V}_{\text{CC}}) & 3.0 \text{V to 15V} \\ \end{array}$ 

Absolute Maximum (V<sub>CC</sub>)
Lead Temperature
(Soldering, 10 seconds)

18V

260°C

**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics table provides conditions for actual device operation.

#### **DC Electrical Characteristics**

Min/max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	CMOS	<b></b>	<u> </u>			
V <sub>IN(1)</sub>	Logical "1" Input Voltage	V <sub>CC</sub> = 5.0V	3.5			V
. ,		V <sub>CC</sub> = 10V	8.0			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 5.0V			1.5	V
		V <sub>CC</sub> = 10V			2.0	V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{CC} = 5.0V$ , $I_{O} = -10 \mu A$	4.5			V
		$V_{CC} = 10V$ , $I_{O} = -10 \mu A$	9.0			V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	$V_{CC} = 5.0V, I_{O} = +10 \mu A$			0.5	V
		$V_{CC} = 10V$ , $I_{O} = +10 \mu A$			1.0	V
I <sub>IN(1)</sub>	Logical "1" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 15V		0.005	1.0	μА
I <sub>IN(0)</sub>	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1.0	-0.005		μΑ
Icc	Supply Current	V <sub>CC</sub> = 15V		0.01	15	μΑ
CMOS/LP	TTL INTERFACE	•	<u>.</u>		ı	
V <sub>IN(1)</sub>	Logical "1" Input Voltage	V <sub>CC</sub> = 4.75V	V <sub>CC</sub> -1.5			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 4.75V			0.8	V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{CC} = 4.75V$ , $I_{O} = -360 \mu A$	2.4			V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	$V_{CC} = 4.75V, I_{O} = 360 \mu A$			0.4	V
	ORIVE (See Family Characteristics	Data Sheet) (Short Circuit Current)				
I <sub>SOURCE</sub>	Output Source Current	$V_{CC} = 5.0V, V_{OUT} = 0V$	-1.75	-3.3		mA
	(P-Channel)	$T_A = 25^{\circ}C$				
I <sub>SOURCE</sub>	Output Source Current	V <sub>CC</sub> = 10V, V <sub>OUT</sub> = 0V	-8.0	-15		mA
	(P-Channel)	T <sub>A</sub> = 25°C				
I <sub>SINK</sub>	Output Sink Current	$V_{CC} = 5.0V$ , $V_{OUT} = V_{CC}$	1.75	3.6		mA
	(N-Channel)	T <sub>A</sub> = 25°C				
I <sub>SINK</sub>	Output Sink Current	$V_{CC} = 10V$ , $V_{OUT} = V_{CC}$	8.0	16		mA
	(N-Channel)	T <sub>A</sub> = 25°C				

#### **AC Electrical Characteristics** (Note 2)

 $\rm T_A = 25^{\circ}C,\, C_L = 50$  pF, unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>pd</sub>	Propagation Time to Logical	$V_{CC} = 5.0V$		110	185	ns
	"1" or "0"	V <sub>CC</sub> = 10V		50	90	ns
C <sub>IN</sub>	Input Capacitance	(Note 3)		5.0		pF
C <sub>PD</sub>	Power Dissipation Capacitance	Per Gate (Note 4)		20		pF

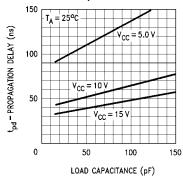
Note 2: AC Parameters are guaranteed by DC correlated testing.

Note 3: Capacitance is guaranteed by periodic testing.

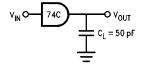
Note 4: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see Family Characteristics Application Note—AN-90.

# **Typical Performance Characteristics**

#### Propagation Delay Time vs Load Capacitance

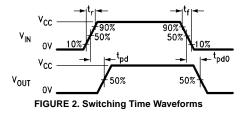


## **Test Circuits and Waveforms**



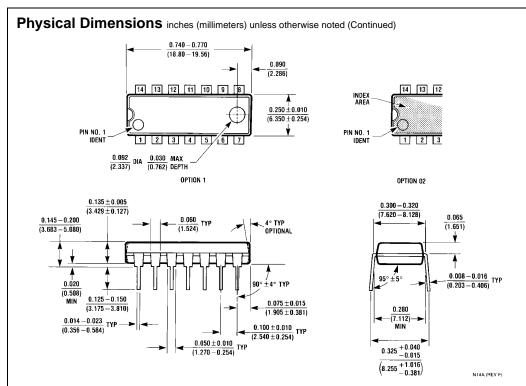
Delays Measured with Input  $t_{r,} \ t_{f} = 20 \ \text{ns}$ 

FIGURE 1. AC Test Circuit



# Physical Dimensions inches (millimeters) unless otherwise noted $\frac{0.335 - 0.344}{(8.509 - 8.738)}$ LEAD NO. 1 IDENT $\frac{0.150 - 0.157}{(3.810 - 3.988)}$ $\frac{0.053 - 0.069}{(1.346 - 1.753)}$ $\frac{0.010-0.020}{(0.254-0.508)}$ 8° MAX TYP ALL LEADS $\frac{0.004 - 0.010}{(0.102 - 0.254)}$ SEATING PLANE 0.014 (0.356) 0.008-0.010 (0.203-0.254) TYP ALL LEADS $-\frac{0.014 - 0.020}{(0.356 - 0.508)} \text{ TYP}$ 0.050 (1.270) TYP 0.016 - 0.050 (0.406 - 1.270) TYP ALL LEADS 0.004 (0.102) ALL LEAD TIPS $-\frac{0.008}{(0.203)}$ TYP

14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow Package Number M14A



# 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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